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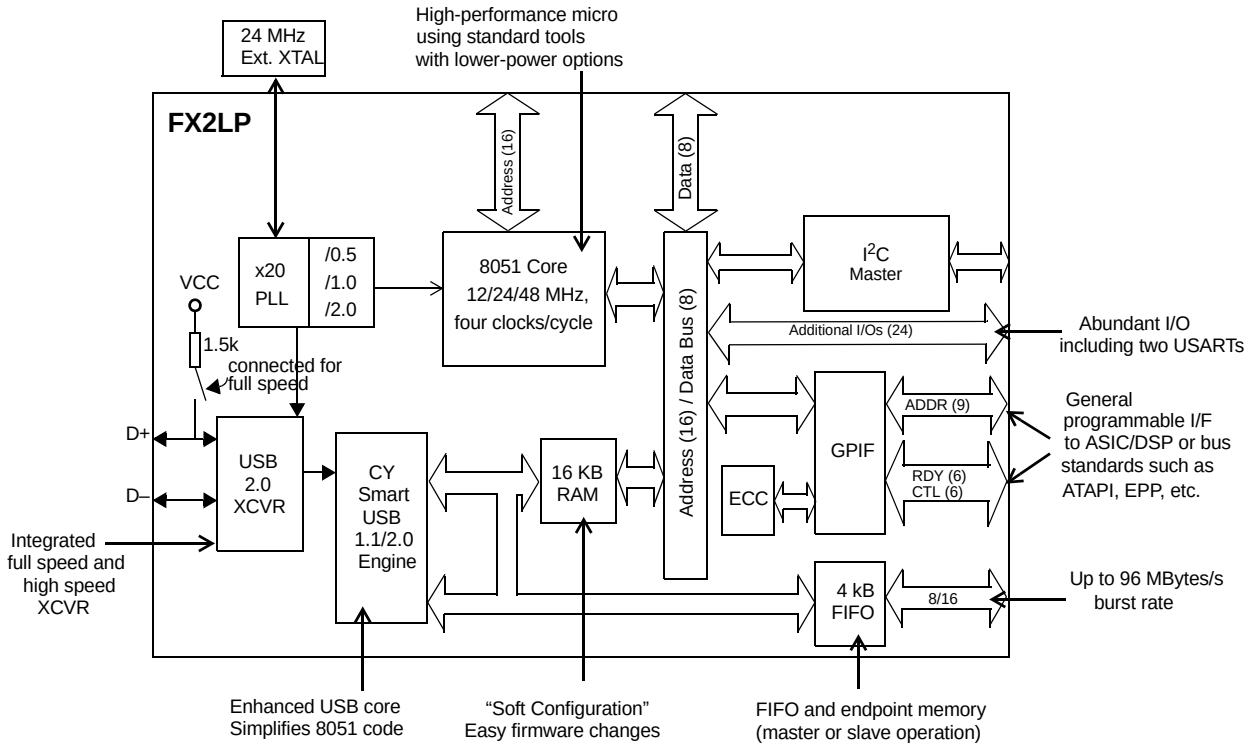
What Are Embedded - Microcontrollers - Application Specific?

Application-specific microcontrollers are engineered to

Details	
Product Status	Active
Applications	USB Microcontroller
Core Processor	8051
Program Memory Type	ROMless
Controller Series	CY7C680xx
RAM Size	16K x 8
Interface	I²C, USB, USART
Number of I/O	40
Voltage - Supply	3V ~ 3.6V
Operating Temperature	0°C ~ 70°C
Mounting Type	Surface Mount
Package / Case	128-LQFP
Supplier Device Package	128-TQFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy7c68014a-128axc

Logic Block Diagram



Cypress's EZ-USB® FX2LP™ (CY7C68013A/14A) is a low-power version of the EZ-USB FX2™ (CY7C68013), which is a highly integrated, low-power USB 2.0 microcontroller. By integrating the USB 2.0 transceiver, serial interface engine (SIE), enhanced 8051 microcontroller, and a programmable peripheral interface in a single chip, Cypress has created a cost-effective solution that provides superior time-to-market advantages with low power to enable bus-powered applications.

The ingenious architecture of FX2LP results in data transfer rates of over 53 Mbytes per second (the maximum allowable USB 2.0 bandwidth), while still using a low-cost 8051 microcontroller in a package as small as a 56 VFBGA (5 mm x 5 mm). Because it incorporates the USB 2.0 transceiver, the FX2LP is more economical, providing a smaller-footprint solution than a USB 2.0 SIE or external transceiver implementations.

With EZ-USB FX2LP, the Cypress Smart SIE handles most of the USB 1.1 and 2.0 protocol in hardware, freeing the embedded microcontroller for application-specific functions and decreasing the development time to ensure USB compatibility.

The general programmable interface (GPIF) and Master/Slave Endpoint FIFO (8-bit or 16-bit data bus) provide an easy and glueless interface to popular interfaces such as ATA, UTOPIA, EPP, PCMCIA, and most DSP/processors.

The FX2LP draws less current than the FX2 (CY7C68013), has double the on-chip code/data RAM, and is fit, form, and function compatible with the 56-, 100-, and 128-pin FX2.

Five packages are defined for the family: 56 VFBGA, 56 SSOP, 56 QFN, 100 TQFP, and 128 TQFP.

Applications

- Portable video recorder
- MPEG/TV conversion
- DSL modems
- ATA interface
- Memory card readers
- Legacy conversion devices
- Cameras
- Scanners
- Wireless LAN
- MP3 players
- Networking

The “Reference Designs” section of the Cypress web site provides additional tools for typical USB 2.0 applications. Each reference design comes complete with firmware source and object code, schematics, and documentation. Visit www.cypress.com for more information.

Functional Overview

USB Signaling Speed

FX2LP operates at two of the three rates defined in the USB Specification Revision 2.0, dated April 27, 2000:

- Full speed, with a signaling bit rate of 12 Mbps
- High speed, with a signaling bit rate of 480 Mbps

FX2LP does not support the Low Speed signaling mode of 1.5 Mbps.

8051 Microprocessor

The 8051 microprocessor embedded in the FX2LP family has 256 bytes of register RAM, an expanded interrupt system, three timer/counters, and two USARTs.

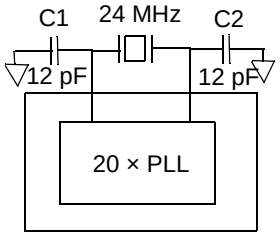
8051 Clock Frequency

FX2LP has an on-chip oscillator circuit that uses an external 24-MHz (±100 ppm) crystal with the following characteristics:

- Parallel resonant
- Fundamental mode
- 500-µW drive level
- 12-pF (5% tolerance) load capacitors

An on-chip PLL multiplies the 24-MHz oscillator up to 480 MHz, as required by the transceiver/PHY; internal counters divide it down for use as the 8051 clock. The default 8051 clock frequency is 12 MHz. The clock frequency of the 8051 can be changed by the 8051 through the CPUCS register, dynamically.

Figure 1. Crystal Configuration



12-pF capacitor values assume a trace capacitance of 3 pF per side on a four-layer FR4 PCA

The CLKOUT pin, which can be three-stated and inverted using internal control bits, outputs the 50% duty cycle 8051 clock, at the selected 8051 clock frequency: 48 MHz, 24 MHz, or 12 MHz.

USARTs

FX2LP contains two standard 8051 USARTs, addressed through Special Function Register (SFR) bits. The USART interface pins are available on separate I/O pins, and are not multiplexed with port pins.

UART0 and UART1 can operate using an internal clock at 230 KBaud with no more than 1% baud rate error. 230 KBaud operation is achieved by an internally derived clock source that generates overflow pulses at the appropriate time. The internal clock adjusts for the 8051 clock rate (48 MHz, 24 MHz, and 12 MHz) such that it always presents the correct frequency for the 230-KBaud operation.[1]

Special Function Registers

Certain 8051 SFR addresses are populated to provide fast access to critical FX2LP functions. These SFR additions are shown in Table 1 on page 6. Bold type indicates nonstandard, enhanced 8051 registers. The two SFR rows that end with “0” and “8” contain bit-addressable registers. The four I/O ports A to D use the SFR addresses used in the standard 8051 for ports 0 to 3, which are not implemented in FX2LP. Because of the faster and more efficient SFR addressing, the FX2LP I/O ports are not addressable in external RAM space (using the MOVX instruction).

I^2C Bus

FX2LP supports the I^2C bus as a master only at 100/400 kHz. SCL and SDA pins have open-drain outputs and hysteresis inputs. These signals must be pulled up to 3.3 V, even if no I^2C device is connected.

Buses

All packages, 8-bit or 16-bit “FIFO” bidirectional data bus, multiplexed on I/O ports B and D. 128-pin package: adds 16-bit output-only 8051 address bus, 8-bit bidirectional data bus.

Note
1. 115-KBaud operation is also possible by programming the 8051 SMOD0 or SMOD1 bits to a “1” for UART0, UART1, or both respectively.

The FX2LP jump instruction is encoded as follows:.

Table 3. INT2 USB Interrupts

USB INTERRUPT TABLE FOR INT2			
Priority	**INT2VEC Value**	**Source**	**Notes**
1	00	SUDAV	Setup data available
2	04	SOF	Start of frame (or microframe)
3	08	SUTOK	Setup token received
4	0C	SUSPEND	USB suspend request
5	10	USB RESET	Bus reset
6	14	HISPEED	Entered high speed operation
7	18	EP0ACK	FX2LP ACK'd the CONTROL Handshake
8	1C		reserved
9	20	EP0-IN	EP0-IN ready to be loaded with data
10	24	EP0-OUT	EP0-OUT has USB data
11	28	EP1-IN	EP1-IN ready to be loaded with data
12	2C	EP1-OUT	EP1-OUT has USB data
13	30	EP2	IN: buffer available. OUT: buffer has data
14	34	EP4	IN: buffer available. OUT: buffer has data
15	38	EP6	IN: buffer available. OUT: buffer has data
16	3C	EP8	IN: buffer available. OUT: buffer has data
17	40	IBN	IN-Bulk-NAK (any IN endpoint)
18	44		reserved
19	48	EP0PING	EP0 OUT was pinged and it NAK'd
20	4C	EP1PING	EP1 OUT was pinged and it NAK'd
21	50	EP2PING	EP2 OUT was pinged and it NAK'd
22	54	EP4PING	EP4 OUT was pinged and it NAK'd
23	58	EP6PING	EP6 OUT was pinged and it NAK'd
24	5C	EP8PING	EP8 OUT was pinged and it NAK'd
25	60	ERRLIMIT	Bus errors exceeded the programmed limit
26	64	–	–
27	68	–	Reserved
28	6C	–	Reserved
29	70	EP2ISOERR	ISO EP2 OUT PID sequence error
30	74	EP4ISOERR	ISO EP4 OUT PID sequence error
31	78	EP6ISOERR	ISO EP6 OUT PID sequence error
32	7C	EP8ISOERR	ISO EP8 OUT PID sequence error

If Autovectoring is enabled (AV2EN = 1 in the INTSET-UP register), the FX2LP substitutes its INT2VEC byte. Therefore, if the high byte ("page") of a jump table address is preloaded at the location 0x0044, the automatically inserted INT2VEC byte at 0x0045 directs the jump to the correct address out of the 27 addresses within the page.

FIFO/GPIF Interrupt (INT4)

Just as the USB Interrupt is shared among 27 individual USB interrupt sources, the FIFO/GPIF interrupt is shared among 14 individual FIFO/GPIF sources. The FIFO/GPIF Interrupt, similar to the USB Interrupt, can employ autovectoring.

Table 4 on page 8 shows the priority and INT4VEC values for the 14 FIFO/GPIF interrupt sources.

Table 4. Individual FIFO/GPIF Interrupt Sources

Priority	INT4VEC Value	Source	Notes
1	80	EP2PF	Endpoint 2 programmable flag
2	84	EP4PF	Endpoint 4 programmable flag
3	88	EP6PF	Endpoint 6 programmable flag
4	8C	EP8PF	Endpoint 8 programmable flag
5	90	EP2EF	Endpoint 2 empty flag [3]
6	94	EP4EF	Endpoint 4 empty flag
7	98	EP6EF	Endpoint 6 empty flag
8	9C	EP8EF	Endpoint 8 empty flag
9	A0	EP2FF	Endpoint 2 full flag
10	A4	EP4FF	Endpoint 4 full flag
11	A8	EP6FF	Endpoint 6 full flag
12	AC	EP8FF	Endpoint 8 full flag
13	B0	GPIFDONE	GPIF operation complete
14	B4	GPIFWF	GPIF waveform

If Autovectoring is enabled (AV4EN = 1 in the INTSET-UP register), the FX 2LP substitutes its INT4VEC byte. Therefore, if the high byte (“page”) of a jump-table address is preloaded at location 0x0054, the automatically inserted INT4VEC byte at 0x0055 directs the jump to the correct address out of the 14 addresses within the page. When the ISR occurs, the FX2LP pushes the program counter to its stack then jumps to address 0x0053, where it expects to find a “jump” instruction to the interrupt service routine (ISR).

Note
3. Errata: In Slave FIFO Asynchronous Word Wide mode, if a single word data is transferred from the USB host to EP2, configured as OUT Endpoint (EP) in the first transaction, then the Empty flag behaves incorrectly. This does not happen if the data size is more than one word in the first transaction. For more information, see the “Errata” on page 65.

Figure 11. CY7C68013A 56-pin VFBGA Pin Assignment – Top View

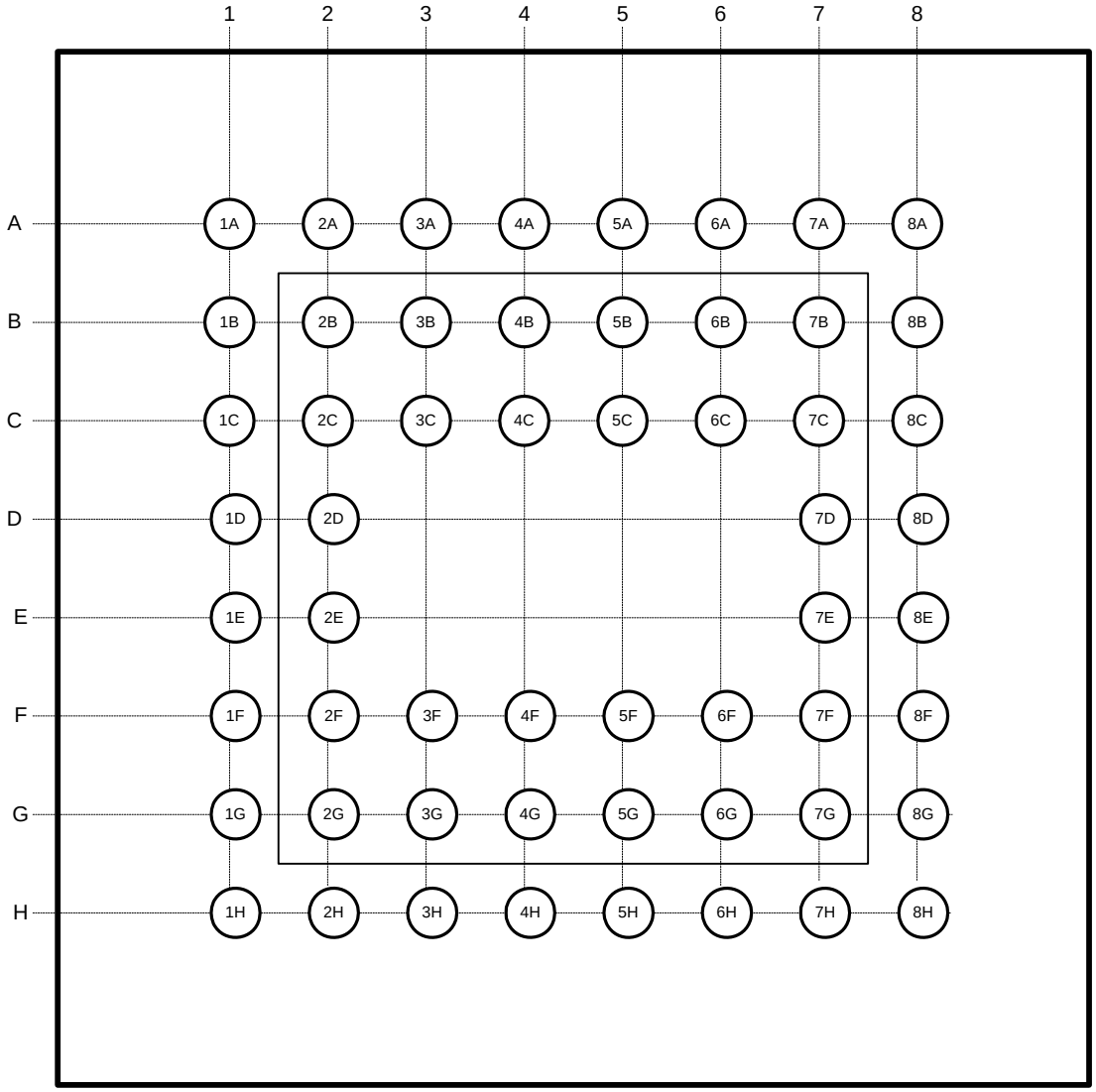


Table 11. FX2LP Pin Descriptions[11] (continued)

128 TQFP	100 TQFP	56 SSOP	56 QFN	56 VFBGA	Name	Type	Default	Reset[12]	Description
47	37	28	21	4G	PB3 or FD[3]	I/O/Z	I (PB3)	Z (PB3)	Multiplexed pin whose function is selected by the following bits: IFCONFIG[1..0]. **PB3** is a bidirectional I/O port pin. **FD[3]** is the bidirectional FIFO/GPIF data bus.
54	44	29	22	5H	PB4 or FD[4]	I/O/Z	I (PB4)	Z (PB4)	Multiplexed pin whose function is selected by the following bits: IFCONFIG[1..0]. **PB4** is a bidirectional I/O port pin. **FD[4]** is the bidirectional FIFO/GPIF data bus.
55	45	30	23	5G	PB5 or FD[5]	I/O/Z	I (PB5)	Z (PB5)	Multiplexed pin whose function is selected by the following bits: IFCONFIG[1..0]. **PB5** is a bidirectional I/O port pin. **FD[5]** is the bidirectional FIFO/GPIF data bus.
56	46	31	24	5F	PB6 or FD[6]	I/O/Z	I (PB6)	Z (PB6)	Multiplexed pin whose function is selected by the following bits: IFCONFIG[1..0]. **PB6** is a bidirectional I/O port pin. **FD[6]** is the bidirectional FIFO/GPIF data bus.
57	47	32	25	6H	PB7 or FD[7]	I/O/Z	I (PB7)	Z (PB7)	Multiplexed pin whose function is selected by the following bits: IFCONFIG[1..0]. **PB7** is a bidirectional I/O port pin. **FD[7]** is the bidirectional FIFO/GPIF data bus.
PORT C									
72	57	–	–	–	PC0 or GPIFADR0	I/O/Z	I (PC0)	Z (PC0)	Multiplexed pin whose function is selected by PORTCCFG.0 **PC0** is a bidirectional I/O port pin. **GPIFADR0** is a GPIF address output pin.
73	58	–	–	–	PC1 or GPIFADR1	I/O/Z	I (PC1)	Z (PC1)	Multiplexed pin whose function is selected by PORTCCFG.1 **PC1** is a bidirectional I/O port pin. **GPIFADR1** is a GPIF address output pin.
74	59	–	–	–	PC2 or GPIFADR2	I/O/Z	I (PC2)	Z (PC2)	Multiplexed pin whose function is selected by PORTCCFG.2 **PC2** is a bidirectional I/O port pin. **GPIFADR2** is a GPIF address output pin.
75	60	–	–	–	PC3 or GPIFADR3	I/O/Z	I (PC3)	Z (PC3)	Multiplexed pin whose function is selected by PORTCCFG.3 **PC3** is a bidirectional I/O port pin. **GPIFADR3** is a GPIF address output pin.
76	61	–	–	–	PC4 or GPIFADR4	I/O/Z	I (PC4)	Z (PC4)	Multiplexed pin whose function is selected by PORTCCFG.4 **PC4** is a bidirectional I/O port pin. **GPIFADR4** is a GPIF address output pin.
77	62	–	–	–	PC5 or GPIFADR5	I/O/Z	I (PC5)	Z (PC5)	Multiplexed pin whose function is selected by PORTCCFG.5 **PC5** is a bidirectional I/O port pin. **GPIFADR5** is a GPIF address output pin.
78	63	–	–	–	PC6 or GPIFADR6	I/O/Z	I (PC6)	Z (PC6)	Multiplexed pin whose function is selected by PORTCCFG.6 **PC6** is a bidirectional I/O port pin. **GPIFADR6** is a GPIF address output pin.
79	64	–	–	–	PC7 or GPIFADR7	I/O/Z	I (PC7)	Z (PC7)	Multiplexed pin whose function is selected by PORTCCFG.7 **PC7** is a bidirectional I/O port pin. **GPIFADR7** is a GPIF address output pin.

Table 11. FX2LP Pin Descriptions[11] (continued)

128 TQFP	100 TQFP	56 SSOP	56 QFN	56 VFBGA	Name	Type	Default	Reset[12]	Description
PORT D									
102	80	52	45	8A	PD0 or FD[8]	I/O/Z	I (PD0)	Z (PD0)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[8]** is the bidirectional FIFO/GPIF data bus.
103	81	53	46	7A	PD1 or FD[9]	I/O/Z	I (PD1)	Z (PD1)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[9]** is the bidirectional FIFO/GPIF data bus.
104	82	54	47	6B	PD2 or FD[10]	I/O/Z	I (PD2)	Z (PD2)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[10]** is the bidirectional FIFO/GPIF data bus.
105	83	55	48	6A	PD3 or FD[11]	I/O/Z	I (PD3)	Z (PD3)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[11]** is the bidirectional FIFO/GPIF data bus.
121	95	56	49	3B	PD4 or FD[12]	I/O/Z	I (PD4)	Z (PD4)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[12]** is the bidirectional FIFO/GPIF data bus.
122	96	1	50	3A	PD5 or FD[13]	I/O/Z	I (PD5)	Z (PD5)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[13]** is the bidirectional FIFO/GPIF data bus.
123	97	2	51	3C	PD6 or FD[14]	I/O/Z	I (PD6)	Z (PD6)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[14]** is the bidirectional FIFO/GPIF data bus.
124	98	3	52	2A	PD7 or FD[15]	I/O/Z	I (PD7)	Z (PD7)	Multiplexed pin whose function is selected by the IFCONFIG[1..0] and EPxFIFOCFG.0 (wordwide) bits. **FD[15]** is the bidirectional FIFO/GPIF data bus.
Port E									
108	86	–	–	–	PE0 or T0OUT	I/O/Z	I (PE0)	Z (PE0)	Multiplexed pin whose function is selected by the PORTECFG.0 bit. **PE0** is a bidirectional I/O port pin. **T0OUT** is an active-HIGH signal from 8051 Timer-counter0. T0OUT outputs a high level for one CLKOUT clock cycle when Timer0 overflows. If Timer0 is operated in Mode 3 (two separate timer/counters), T0OUT is active when the low byte timer/counter overflows.
109	87	–	–	–	PE1 or T1OUT	I/O/Z	I (PE1)	Z (PE1)	Multiplexed pin whose function is selected by the PORTECFG.1 bit. **PE1** is a bidirectional I/O port pin. **T1OUT** is an active HIGH signal from 8051 Timer-counter1. T1OUT outputs a high level for one CLKOUT clock cycle when Timer1 overflows. If Timer1 is operated in Mode 3 (two separate timer/counters), T1OUT is active when the low byte timer/counter overflows.

Table 11. FX2LP Pin Descriptions[11] (continued)

128 TQFP	100 TQFP	56 SSOP	56 QFN	56 VFBGA	Name	Type	Default	Reset[12]	Description
30	24	–	–	–	T1	Input	N/A	N/A	**T1** is the active HIGH T1 signal for 8051 Timer1, which provides the input to Timer1 when C/T1 is 1. When C/T1 is 0, Timer1 does not use this bit.
29	23	–	–	–	T0	Input	N/A	N/A	**T0** is the active HIGH T0 signal for 8051 Timer0, which provides the input to Timer0 when C/T0 is 1. When C/T0 is 0, Timer0 does not use this bit.
53	43	–	–	–	RXD1	Input	N/A	N/A	**RXD1**is an active HIGH input signal for 8051 UART1, which provides data to the UART in all modes.
52	42	–	–	–	TXD1	Output	H	L	**TXD1**is an active HIGH output pin from 8051 UART1, which provides the output clock in sync mode, and the output data in async mode.
51	41	–	–	–	RXD0	Input	N/A	N/A	**RXD0** is the active HIGH RXD0 input to 8051 UART0, which provides data to the UART in all modes.
50	40	–	–	–	TXD0	Output	H	L	**TXD0** is the active HIGH TXD0 output from 8051 UART0, which provides the output clock in sync mode, and the output data in async mode.
42		–	–	–	CS#	Output	H	H	**CS#** is the active LOW chip select for external memory.
41	32	–	–	–	WR#	Output	H	H	**WR#** is the active LOW write strobe output for external memory.
40	31	–	–	–	RD#	Output	H	H	**RD#** is the active LOW read strobe output for external memory.
38		–	–	–	OE#	Output	H	H	**OE#** is the active LOW output enable for external memory.
33	27	21	14	2H	Reserved	Input	N/A	N/A	**Reserved**. Connect to ground.
101	79	51	44	7B	WAKEUP	Input	N/A	N/A	**USB Wakeup**. If the 8051 is in suspend, asserting this pin starts up the oscillator and interrupts the 8051 to enable it to exit the suspend mode. Holding WAKEUP asserted inhibits the EZ-USB chip from suspending. This pin has programmable polarity (WAKEUP.4).
36	29	22	15	3F	SCL	OD	Z	Z (if booting is done)	**Clock** for the I^2C interface. Connect to VCC with a 2.2-kΩ resistor, even if no I^2C peripheral is attached.
37	30	23	16	3G	SDA	OD	Z	Z (if booting is done)	**Data** for **I^2C compatible interface**. Connect to VCC with a 2.2-kΩ resistor, **even if no I^2C compatible peripheral is attached**.
2	1	6	55	5A	VCC	Power	N/A	N/A	**VCC**. Connect to the 3.3-V power source.
26	20	18	11	1G	VCC	Power	N/A	N/A	**VCC**. Connect to the 3.3-V power source.
43	33	24	17	7E	VCC	Power	N/A	N/A	**VCC**. Connect to the 3.3-V power source.
48	38	–	–	–	VCC	Power	N/A	N/A	**VCC**. Connect to 3.3-V power source.
64	49	34	27	8E	VCC	Power	N/A	N/A	**VCC**. Connect to the 3.3-V power source.
68	53	–	–	–	VCC	Power	N/A	N/A	**VCC**. Connect to the 3.3-V power source.
81	66	39	32	5C	VCC	Power	N/A	N/A	**VCC**. Connect to the 3.3-V power source.

Table 12. FX2LP Register Summary (continued)

Hex	Size	Name	Description	b7	b6	b5	b4	b3	b2	b1	b0	Default	Access
E62B	1	ECC1B1	ECC1 Byte 1 Address	LINE7	LINE6	LINE5	LINE4	LINE3	LINE2	LINE1	LINE0	00000000	R
E62C	1	ECC1B2	ECC1 Byte 2 Address	COL5	COL4	COL3	COL2	COL1	COL0	LINE17	LINE16	00000000	R
E62D	1	ECC2B0	ECC2 Byte 0 Address	LINE15	LINE14	LINE13	LINE12	LINE11	LINE10	LINE9	LINE8	00000000	R
E62E	1	ECC2B1	ECC2 Byte 1 Address	LINE7	LINE6	LINE5	LINE4	LINE3	LINE2	LINE1	LINE0	00000000	R
E62F	1	ECC2B2	ECC2 Byte 2 Address	COL5	COL4	COL3	COL2	COL1	COL0	0	0	00000000	R
E630 H.S.	1	EP2FIFOPFH[13]	Endpoint 2 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	IN:PKTS[2] OUT:PFC12	IN:PKTS[1] OUT:PFC11	IN:PKTS[0] OUT:PFC10	0	PFC9	PFC8	10001000	bbbbbrbb
E630 F.S.	1	EP2FIFOPFH[13]	Endpoint 2 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	OUT:PFC12	OUT:PFC11	OUT:PFC10	0	PFC9	IN:PKTS[2] OUT:PFC8	10001000	bbbbbrbb
E631 H.S.	1	EP2FIFOPFL[13]	Endpoint 2 / slave FIFO Programmable Flag L	PFC7	PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E631 F.S	1	EP2FIFOPFL[13]	Endpoint 2 / slave FIFO Programmable Flag L	IN:PKTS[1] OUT:PFC7	IN:PKTS[0] OUT:PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E632 H.S.	1	EP4FIFOPFH[13]	Endpoint 4 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	0	IN: PKTS[1] OUT:PFC10	IN: PKTS[0] OUT:PFC9	0	0	PFC8	10001000	bbrbbrrb
E632 F.S	1	EP4FIFOPFH[13]	Endpoint 4 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	0	OUT:PFC10	OUT:PFC9	0	0	PFC8	10001000	bbrbbrrb
E633 H.S.	1	EP4FIFOPFL[13]	Endpoint 4 / slave FIFO Programmable Flag L	PFC7	PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E633 F.S	1	EP4FIFOPFL[13]	Endpoint 4 / slave FIFO Programmable Flag L	IN: PKTS[1] OUT:PFC7	IN: PKTS[0] OUT:PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E634 H.S.	1	EP6FIFOPFH[13]	Endpoint 6 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	IN:PKTS[2] OUT:PFC12	IN:PKTS[1] OUT:PFC11	IN:PKTS[0] OUT:PFC10	0	PFC9	PFC8	00001000	bbbbbrbb
E634 F.S	1	EP6FIFOPFH[13]	Endpoint 6 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	OUT:PFC12	OUT:PFC11	OUT:PFC10	0	PFC9	IN:PKTS[2] OUT:PFC8	00001000	bbbbbrbb
E635 H.S.	1	EP6FIFOPFL[13]	Endpoint 6 / slave FIFO Programmable Flag L	PFC7	PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E635 F.S	1	EP6FIFOPFL[13]	Endpoint 6 / slave FIFO Programmable Flag L	IN:PKTS[1] OUT:PFC7	IN:PKTS[0] OUT:PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E636 H.S.	1	EP8FIFOPFH[13]	Endpoint 8 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	0	IN: PKTS[1] OUT:PFC10	IN: PKTS[0] OUT:PFC9	0	0	PFC8	00001000	bbrbbrrb
E636 F.S	1	EP8FIFOPFH[13]	Endpoint 8 / slave FIFO Programmable Flag H	DECIS	PKTSTAT	0	OUT:PFC10	OUT:PFC9	0	0	PFC8	00001000	bbrbbrrb
E637 H.S.	1	EP8FIFOPFL[13]	Endpoint 8 / slave FIFO Programmable Flag L	PFC7	PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
E637 F.S	1	EP8FIFOPFL[13]	Endpoint 8 / slave FIFO Programmable Flag L	IN: PKTS[1] OUT:PFC7	IN: PKTS[0] OUT:PFC6	PFC5	PFC4	PFC3	PFC2	PFC1	PFC0	00000000	RW
	8	reserved											
E640	1	EP2ISOINPKTS	EP2 (if ISO) IN Packets per frame (1-3)	AADJ	0	0	0	0	0	INPPF1	INPPF0	00000001	brrrrrbb
E641	1	EP4ISOINPKTS	EP4 (if ISO) IN Packets per frame (1-3)	AADJ	0	0	0	0	0	INPPF1	INPPF0	00000001	brrrrrrr
E642	1	EP6ISOINPKTS	EP6 (if ISO) IN Packets per frame (1-3)	AADJ	0	0	0	0	0	INPPF1	INPPF0	00000001	brrrrrbb
E643	1	EP8ISOINPKTS	EP8 (if ISO) IN Packets per frame (1-3)	AADJ	0	0	0	0	0	INPPF1	INPPF0	00000001	brrrrrrr
E644	4	reserved											
E648	1	INPKTEND[13]	Force IN Packet End	Skip	0	0	0	EP3	EP2	EP1	EP0	xxxxxxxx	W
E649	7	OUTPKTEND[13]	Force OUT Packet End	Skip	0	0	0	EP3	EP2	EP1	EP0	xxxxxxxx	W
		INTERRUPTS											
E650	1	EP2FIFOIE[13]	Endpoint 2 slave FIFO Flag Interrupt Enable	0	0	0	0	EDGEPF	PF	EF	FF	00000000	RW
E651	1	EP2FIFOIRQ[13,14]	Endpoint 2 slave FIFO Flag Interrupt Request	0	0	0	0	0	PF	EF	FF	00000000	rrrrrbbb
E652	1	EP4FIFOIE[13]	Endpoint 4 slave FIFO Flag Interrupt Enable	0	0	0	0	EDGEPF	PF	EF	FF	00000000	RW
E653	1	EP4FIFOIRQ[13,14]	Endpoint 4 slave FIFO Flag Interrupt Request	0	0	0	0	0	PF	EF	FF	00000000	rrrrrbbb
E654	1	EP6FIFOIE[13]	Endpoint 6 slave FIFO Flag Interrupt Enable	0	0	0	0	EDGEPF	PF	EF	FF	00000000	RW
E655	1	EP6FIFOIRQ[13,14]	Endpoint 6 slave FIFO Flag Interrupt Request	0	0	0	0	0	PF	EF	FF	00000000	rrrrrbbb
E656	1	EP8FIFOIE[13]	Endpoint 8 slave FIFO Flag Interrupt Enable	0	0	0	0	EDGEPF	PF	EF	FF	00000000	RW
E657	1	EP8FIFOIRQ[13,14]	Endpoint 8 slave FIFO Flag Interrupt Request	0	0	0	0	0	PF	EF	FF	00000000	rrrrrbbb
E658	1	IBNIE	IN-BULK-NAK Interrupt Enable	0	0	EP8	EP6	EP4	EP2	EP1	EP0	00000000	RW
E659	1	IBNIRQ[14]	IN-BULK-NAK interrupt Request	0	0	EP8	EP6	EP4	EP2	EP1	EP0	00xxxxxx	rrbbbbbb
E65A	1	NAKIE	Endpoint Ping-NAK / IBN Interrupt Enable	EP8	EP6	EP4	EP2	EP1	EP0	0	IBN	00000000	RW
E65B	1	NAKIRQ[14]	Endpoint Ping-NAK / IBN Interrupt Request	EP8	EP6	EP4	EP2	EP1	EP0	0	IBN	xxxxxx0x	bbbbbbrb
E65C	1	USBIE	USB Int Enables	0	EP0ACK	HSGRANT	URES	SUSP	SUTOK	SOF	SUDAV	00000000	RW

Note
14. The register can only be reset; it cannot be set.

Table 12. FX2LP Register Summary (continued)

Hex	Size	Name	Description	b7	b6	b5	b4	b3	b2	b1	b0	Default	Access
E65D	1	USBIRQ[14]	USB Interrupt Requests	0	EP0ACK	HSGRANT	URES	SUSP	SUTOK	SOF	SUDAV	0xxxxxxx	rbbbbbbb
E65E	1	EPIE	Endpoint Interrupt Enables	EP8	EP6	EP4	EP2	EP1OUT	EP1IN	EP0OUT	EP0IN	00000000	RW
E65F	1	EPIRQ[14]	Endpoint Interrupt Requests	EP8	EP6	EP4	EP2	EP1OUT	EP1IN	EP0OUT	EP0IN	0	RW
E660	1	GPIFIE[13]	GPIF Interrupt Enable	0	0	0	0	0	0	GPIFWF	GPIFDONE	00000000	RW
E661	1	GPIFIRQ[13]	GPIF Interrupt Request	0	0	0	0	0	0	GPIFWF	GPIFDONE	000000xx	RW
E662	1	USBERRIE	USB Error Interrupt Enables	ISOEP8	ISOEP6	ISOEP4	ISOEP2	0	0	0	ERRLIMIT	00000000	RW
E663	1	USBERRIRQ[14]	USB Error Interrupt Requests	ISOEP8	ISOEP6	ISOEP4	ISOEP2	0	0	0	ERRLIMIT	0000000x	bbbbrrrb
E664	1	ERRCNTLIM	USB Error counter and limit	EC3	EC2	EC1	EC0	LIMIT3	LIMIT2	LIMIT1	LIMIT0	xxxx0100	rrrrbbbb
E665	1	CLRERRCNT	Clear Error Counter EC3:0	x	x	x	x	x	x	x	x	xxxxxxxx	W
E666	1	INT2IVEC	Interrupt 2 (USB) Autovector	0	I2V4	I2V3	I2V2	I2V1	I2V0	0	0	00000000	R
E667	1	INT4IVEC	Interrupt 4 (slave FIFO & GPIF) Autovector	1	0	I4V3	I4V2	I4V1	I4V0	0	0	10000000	R
E668	1	INTSET-UP	Interrupt 2&4 setup	0	0	0	0	AV2EN	0	INT4SRC	AV4EN	00000000	RW
E669	7	reserved											
		INPUT / OUTPUT											
E670	1	PORTACFG	I/O PORTA Alternate Configuration	FLAGD	SLCS	0	0	0	0	INT1	INT0	00000000	RW
E671	1	PORTCCFG	I/O PORTC Alternate Configuration	GPIFA7	GPIFA6	GPIFA5	GPIFA4	GPIFA3	GPIFA2	GPIFA1	GPIFA0	00000000	RW
E672	1	PORTECFG	I/O PORTE Alternate Configuration	GPIFA8	T2EX	INT6	RXD1OUT	RXD0OUT	T2OUT	T1OUT	T0OUT	00000000	RW
E673	4	reserved											
E677	1	reserved											
E678	1	I^2CS	I²C Bus Control & Status	START	STOP	LASTRD	ID1	ID0	BERR	ACK	DONE	000xx000	bbbrrrrr
E679	1	I2DAT	I²C Bus Data	d7	d6	d5	d4	d3	d2	d1	d0	xxxxxxxx	RW
E67A	1	I^2CTL	I²C Bus Control	0	0	0	0	0	0	STOPIE	400KHZ	00000000	RW
E67B	1	XAUTODAT1	Autoptr1 MOVX access, when APTREN=1	D7	D6	D5	D4	D3	D2	D1	D0	xxxxxxxx	RW
E67C	1	XAUTODAT2	Autoptr2 MOVX access, when APTREN=1	D7	D6	D5	D4	D3	D2	D1	D0	xxxxxxxx	RW
		UDMA CRC											
E67D	1	UDMACRCH[13]	UDMA CRC MSB	CRC15	CRC14	CRC13	CRC12	CRC11	CRC10	CRC9	CRC8	01001010	RW
E67E	1	UDMACRCL[13]	UDMA CRC LSB	CRC7	CRC6	CRC5	CRC4	CRC3	CRC2	CRC1	CRC0	10111010	RW
E67F	1	UDMACRC-QUALIFIER	UDMA CRC Qualifier	QENABLE	0	0	0	QSTATE	QSIGNAL2	QSIGNAL1	QSIGNAL0	00000000	brrrbbbb
		USB CONTROL											
E680	1	USBCS	USB Control & Status	HSM	0	0	0	DISCON	NOSYNSOF	RENUM	SIGRSUME	x0000000	rrrrbbbb
E681	1	SUSPEND	Put chip into suspend	x	x	x	x	x	x	x	x	xxxxxxxx	W
E682	1	WAKEUPCS	Wakeup Control & Status	WU2	WU	WU2POL	WUPOL	0	DPEN	WU2EN	WUEN	xx000101	bbbbrbbb
E683	1	TOGCTL	Toggle Control	Q	S	R	I/O	EP3	EP2	EP1	EP0	x0000000	rrrbbbbb
E684	1	USBFRAMEH	USB Frame count H	0	0	0	0	0	FC10	FC9	FC8	00000xxx	R
E685	1	USBFRAMEL	USB Frame count L	FC7	FC6	FC5	FC4	FC3	FC2	FC1	FC0	xxxxxxxx	R
E686	1	MICROFRAME	Microframe count, 0-7	0	0	0	0	0	MF2	MF1	MF0	00000xxx	R
E687	1	FNADDR	USB Function address	0	FA6	FA5	FA4	FA3	FA2	FA1	FA0	0xxxxxxx	R
E688	2	reserved											
		ENDPOINTS											
E68A	1	EP0BCH[13]	Endpoint 0 Byte Count H	(BC15)	(BC14)	(BC13)	(BC12)	(BC11)	(BC10)	(BC9)	(BC8)	xxxxxxxx	RW
E68B	1	EP0BCL[13]	Endpoint 0 Byte Count L	(BC7)	BC6	BC5	BC4	BC3	BC2	BC1	BC0	xxxxxxxx	RW
E68C	1	reserved											
E68D	1	EP1OUTBC	Endpoint 1 OUT Byte Count	0	BC6	BC5	BC4	BC3	BC2	BC1	BC0	0xxxxxxx	RW
E68E	1	reserved											
E68F	1	EP1INBC	Endpoint 1 IN Byte Count	0	BC6	BC5	BC4	BC3	BC2	BC1	BC0	0xxxxxxx	RW
E690	1	EP2BCH[13]	Endpoint 2 Byte Count H	0	0	0	0	0	BC10	BC9	BC8	00000xxx	RW
E691	1	EP2BCL[13]	Endpoint 2 Byte Count L	BC7/SKIP	BC6	BC5	BC4	BC3	BC2	BC1	BC0	xxxxxxxx	RW
E692	2	reserved											
E694	1	EP4BCH[13]	Endpoint 4 Byte Count H	0	0	0	0	0	0	BC9	BC8	000000xx	RW
E695	1	EP4BCL[13]	Endpoint 4 Byte Count L	BC7/SKIP	BC6	BC5	BC4	BC3	BC2	BC1	BC0	xxxxxxxx	RW
E696	2	reserved											
E698	1	EP6BCH[13]	Endpoint 6 Byte Count H	0	0	0	0	0	BC10	BC9	BC8	00000xxx	RW
E699	1	EP6BCL[13]	Endpoint 6 Byte Count L	BC7/SKIP	BC6	BC5	BC4	BC3	BC2	BC1	BC0	xxxxxxxx	RW
E69A	2	reserved											
E69C	1	EP8BCH[13]	Endpoint 8 Byte Count H	0	0	0	0	0	0	BC9	BC8	000000xx	RW
E69D	1	EP8BCL[13]	Endpoint 8 Byte Count L	BC7/SKIP	BC6	BC5	BC4	BC3	BC2	BC1	BC0	xxxxxxxx	RW
E69E	2	reserved											

Table 12. FX2LP Register Summary (continued)

Hex	Size	Name	Description	b7	b6	b5	b4	b3	b2	b1	b0	Default	Access
BE	1	GPIFSGLDATLX[15]	GPIF Data L w/ Trigger	D7	D6	D5	D4	D3	D2	D1	D0	xxxxxxxx	RW
BF	1	GPIFSGLDATL-NOX[15]	GPIF Data L w/ No Trigger	D7	D6	D5	D4	D3	D2	D1	D0	xxxxxxxx	R
C0	1	SCON1[15]	Serial Port 1 Control (bit addressable)	SM0_1	SM1_1	SM2_1	REN_1	TB8_1	RB8_1	TI_1	RI_1	00000000	RW
C1	1	SBUF1[15]	Serial Port 1 Data Buffer	D7	D6	D5	D4	D3	D2	D1	D0	00000000	RW
C2	6	reserved											
C8	1	T2CON	Timer/Counter 2 Control (bit addressable)	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	CT2	CPRL2	00000000	RW
C9	1	reserved											
CA	1	RCAP2L	Capture for Timer 2, auto-reload, up-counter	D7	D6	D5	D4	D3	D2	D1	D0	00000000	RW
CB	1	RCAP2H	Capture for Timer 2, auto-reload, up-counter	D7	D6	D5	D4	D3	D2	D1	D0	00000000	RW
CC	1	TL2	Timer 2 reload L	D7	D6	D5	D4	D3	D2	D1	D0	00000000	RW
CD	1	TH2	Timer 2 reload H	D15	D14	D13	D12	D11	D10	D9	D8	00000000	RW
CE	2	reserved											
D0	1	PSW	Program Status Word (bit addressable)	CY	AC	F0	RS1	RS0	OV	F1	P	00000000	RW
D1	7	reserved											
D8	1	EICON[15]	External Interrupt Control	SMOD1	1	ERESI	RESI	INT6	0	0	0	01000000	RW
D9	7	reserved											
E0	1	ACC	Accumulator (bit addressable)	D7	D6	D5	D4	D3	D2	D1	D0	00000000	RW
E1	7	reserved											
E8	1	EIE[15]	External Interrupt Enable(s)	1	1	1	EX6	EX5	EX4	EI²C	EUSB	11100000	RW
E9	7	reserved											
F0	1	B	B (bit addressable)	D7	D6	D5	D4	D3	D2	D1	D0	00000000	RW
F1	7	reserved											
F8	1	EIP[15]	External Interrupt Priority Control	1	1	1	PX6	PX5	PX4	PI²C	PUSB	11100000	RW
F9	7	reserved											

R = all bits read-only
W = all bits write-only
r = read-only bit
w = write-only bit
b = both read/write bit

Absolute Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Storage temperature ..... –65 °C to +150 °C

Ambient temperature with power supplied (commercial)..... 0 °C to +70 °C

Ambient temperature with power supplied (industrial)..... –40 °C to + 105 °C

Supply voltage to ground potential .....–0.5 V to +4.0 V

DC input voltage to any input pin[17] ..... 5.25 V

DC voltage applied to outputs in high Z state ..... –0.5 V to V_{CC} + 0.5 V

Power dissipation ..... 300 mW

Static discharge voltage..... .....>2000 V

Max output current, per I/O port ..... 10 mA

Max output current, all five I/O ports (128-pin and 100-pin packages)..... 50 mA

Operating Conditions

T_A (ambient temperature under bias) Commercial ..... 0 °C to +70 °C

T_A (ambient temperature under bias) Industrial ..... –40 °C to +105 °C

Supply voltage .....+3.00 V to +3.60 V

Ground voltage ..... 0 V

F_{OSC} (oscillator or crystal frequency) ..... 24 MHz ± 100 ppm, parallel resonant

Thermal Characteristics

The following table displays the thermal characteristics of various packages:

Table 13. Thermal Characteristics

Package	Ambient Temperature (°C)	θ_{Jc} Junction to Case Thermal Resistance (°C/W)	θ_{Ja} Junction to Ambient Thermal Resistance (°C/W)
56 SSOP	70	24.4	47.7
100 TQFP	70	11.9	45.9
128 TQFP	70	15.5	43.2
56 QFN	70	10.6	25.2
56 VFBGA	70	30.9	58.6

The junction temperature θ_j, can be calculated using the following equation: $\theta_j = P*\theta_{Ja} + \theta_a$

Where,

P = Power

θ_{Ja} = Junction to ambient temperature ($\theta_{Jc} + \theta_{Ca}$)

θ_a = Ambient temperature (70 °C)

The case temperature θ_c, can be calculated using the following equation: $\theta_c = P*\theta_{Ca} + \theta_a$

where,

P = Power

θ_{Ca} = Case to ambient temperature

θ_a = Ambient temperature (70 °C)

Note
17. Do not power I/O with the chip power OFF.

DC Characteristics

Table 14. DC Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
VCC	Supply voltage	–	3.00	3.3	3.60	V
VCC Ramp Up	0 to 3.3 V	–	200	–	–	µs
V_{IH}	Input HIGH voltage	–	2	–	5.25	V
V_{IL}	Input LOW voltage	–	–0.5	–	0.8	V
V_{IH_X}	Crystal input HIGH voltage	–	2	–	5.25	V
V_{IL_X}	Crystal input LOW voltage	–	–0.5	–	0.8	V
I_I	Input leakage current	$0< V_{IN} < V_{CC}$	–	–	±10	µA
V_{OH}	Output voltage HIGH	I_{OUT} = 4 mA	2.4	–	–	V
V_{OL}	Output LOW voltage	I_{OUT} = –4 mA	–	–	0.4	V
I_{OH}	Output current HIGH	–	–	–	4	mA
I_{OL}	Output current LOW	–	–	–	4	mA
C_{IN}	Input pin capacitance	Except D+/D–	–	–	10	pF
		D+/D–	–	–	15	pF
I_{SUSP}	Suspend current CY7C68014/CY7C68016	Connected	–	300	380[18]	µA
		Disconnected	–	100	150[18]	µA
	Suspend current CY7C68013/CY7C68015	Connected	–	0.5	1.2[18]	mA
		Disconnected	–	0.3	1.0[18]	mA
I_{CC}	Supply current	8051 running, connected to USB HS	–	50	85	mA
		8051 running, connected to USB FS	–	35	65	mA
T_{RESET}	Reset time after valid power	V_{CC} min = 3.0 V	5.0	–	–	ms
	Pin reset after powered on		200	–	–	µs

USB Transceiver

USB 2.0 compliant in Full Speed and Hi-Speed modes.

Note
18. Measured at Max V_{CC}, 25 °C.

Data Memory Write[23]

Figure 14. Data Memory Write Timing Diagram

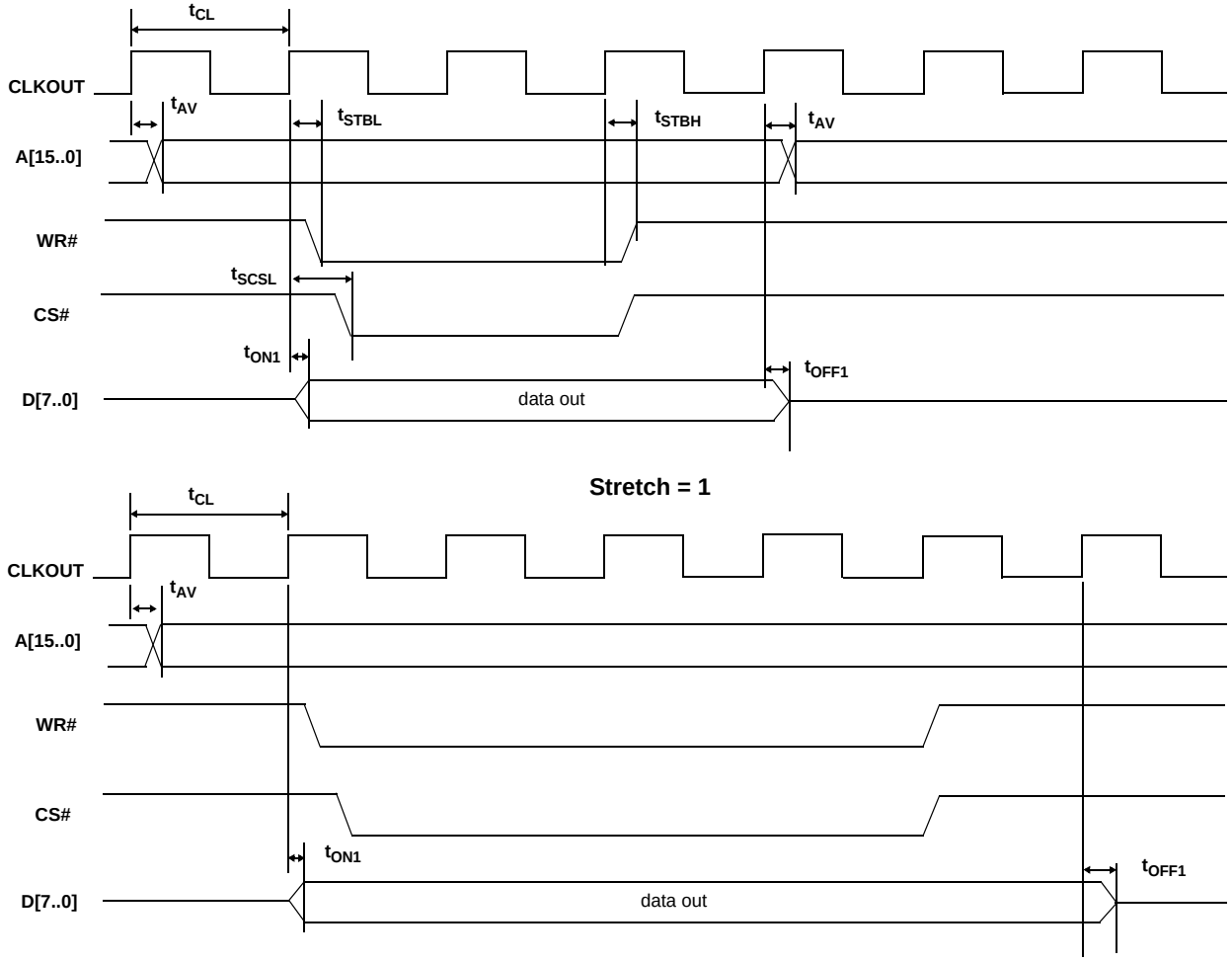


Table 17. Data Memory Write Parameters

Parameter	Description	Min	Max	Unit	Notes
t_{AV}	Delay from clock to valid address	0	10.7	ns	–
t_{STBL}	Clock to WR pulse LOW	0	11.2	ns	–
t_{STBH}	Clock to WR pulse HIGH	0	11.2	ns	–
t_{SCSL}	Clock to CS pulse LOW	–	13.0	ns	–
t_{ON1}	Clock to data turn-on	0	13.1	ns	–
t_{OFF1}	Clock to data hold time	0	13.1	ns	–

When using the AUTPOPTR1 or AUTOPTR2 to address external memory, the address of AUTOPTR1 is only active while either RD# or WR# are active. The address of AUTOPTR2 is active throughout the cycle and meets the address valid time for which is based on the stretch value.

Note
23. The stretch memory cycle feature enables EZ-USB firmware to adjust the speed of data memory accesses not the program memory accesses. Details including typical strobe width timings can be found in the section 12.1.2 of the Technical Reference Manual. The address cycle width can be interpreted from these.

GPIF Synchronous Signals

Figure 18. GPIF Synchronous Signals Timing Diagram[24]

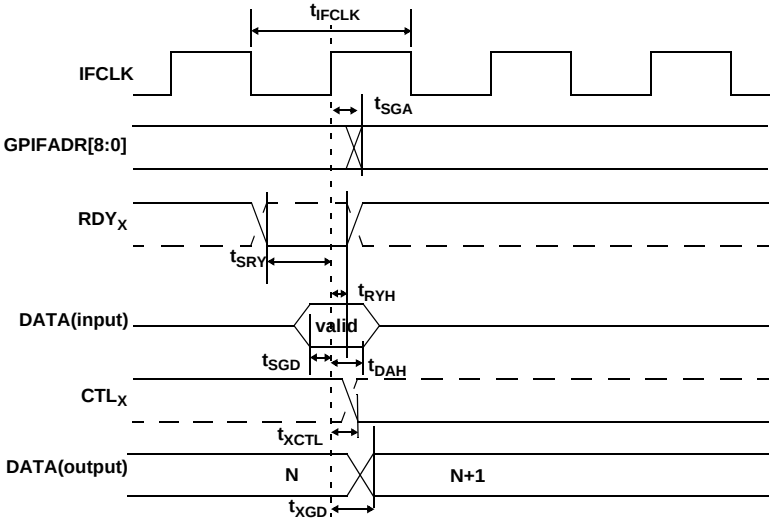


Table 18. GPIF Synchronous Signals Parameters with Internally Sourced IFCLK[24, 25]

Parameter	Description	Min	Max	Typ		Unit
				Min	Max	
t_{IFCLK}	IFCLK Period	20.83	–	–	–	ns
t_{SRY}	RDY_X to clock setup time	8.9	–	–	–	ns
t_{RYH}	Clock to RDY_X	0	–	–	–	ns
t_{SGD}	GPIF data to clock setup time	9.2	–	–	–	ns
t_{DAH}	GPIF data hold time	0	–	–	–	ns
t_{SGA}	Clock to GPIF address propagation delay	–	7.5	–	–	ns
t_{XGD}	Clock to GPIF data output propagation delay	–	11	–	–	ns
t_{XCTL}	Clock to CTL_X output propagation delay	–	6.7	–	–	ns
t_{IFCLKR}	IFCLK rise time	–	–	–	900	ps
t_{IFCLKF}	IFCLK fall time	–	–	–	900	ps
$t_{IFCLKOD}$	IFCLK output duty cycle	–	–	49	51	%
t_{IFCLKJ}	IFCLK jitter peak to peak	–	–	–	300	ps

Table 19. GPIF Synchronous Signals Parameters with Externally Sourced IFCLK[25]

Parameter	Description	Min	Max	Unit
t_{IFCLK}	IFCLK period[26]	20.83	200	ns
t_{SRY}	RDY_X to clock setup time	2.9	–	ns
t_{RYH}	Clock to RDY_X	3.7	–	ns
t_{SGD}	GPIF data to clock setup time	3.2	–	ns
t_{DAH}	GPIF data hold time	4.5	–	ns
t_{SGA}	Clock to GPIF address propagation delay	–	11.5	ns
t_{XGD}	Clock to GPIF data output propagation delay	–	15	ns
t_{XCTL}	Clock to CTL_X output propagation delay	–	10.7	ns

Notes
24. Dashed lines denote signals with programmable polarity.
25. GPIF asynchronous RDY_x signals have a minimum setup time of 50 ns when using the internal 48-MHz IFCLK.
26. IFCLK must not exceed 48 MHz.

Table 21. Slave FIFO Synchronous Read Parameters with Externally Sourced IFCLK[25]

Parameter	Description	Min	Max	Unit
t_{IFCLK}	IFCLK period	20.83	200	ns
t_{SRD}	SLRD to clock setup time	12.7	–	ns
t_{RDH}	Clock to SLRD hold time	3.7	–	ns
t_{OEon}	SLOE turn on to FIFO data valid	–	10.5	ns
t_{OEoff}	SLOE turn off to FIFO data hold	–	10.5	ns
t_{XFLG}	Clock to FLAGS output propagation delay	–	13.5	ns
t_{XFD}	Clock to FIFO data output propagation delay	–	15	ns

Slave FIFO Asynchronous Read

Figure 20. Slave FIFO Asynchronous Read Timing Diagram[24]

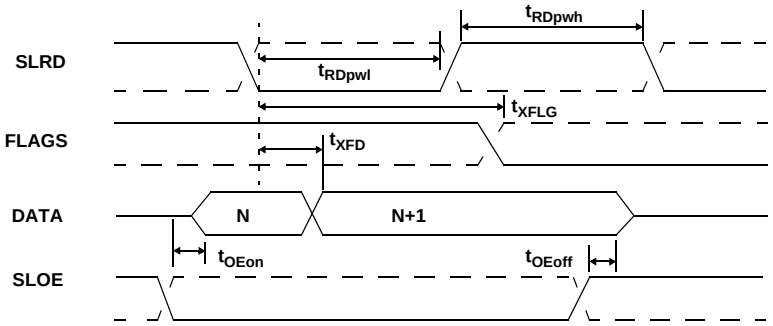


Table 22. Slave FIFO Asynchronous Read Parameters[27]

Parameter	Description	Min	Max	Unit
t_{RDpwl}	SLRD pulse width LOW	50	–	ns
t_{RDpwh}	SLRD pulse width HIGH	50	–	ns
t_{XFLG}	SLRD to FLAGS output propagation delay	–	70	ns
t_{XFD}	SLRD to FIFO data output propagation delay	–	15	ns
t_{OEon}	SLOE turn-on to FIFO data valid	–	10.5	ns
t_{OEoff}	SLOE turn-off to FIFO data hold	–	10.5	ns

Note
27. Slave FIFO asynchronous parameter values use internal IFCLK setting at 48 MHz.

Slave FIFO Synchronous Write

Figure 21. Slave FIFO Synchronous Write Timing Diagram[24]

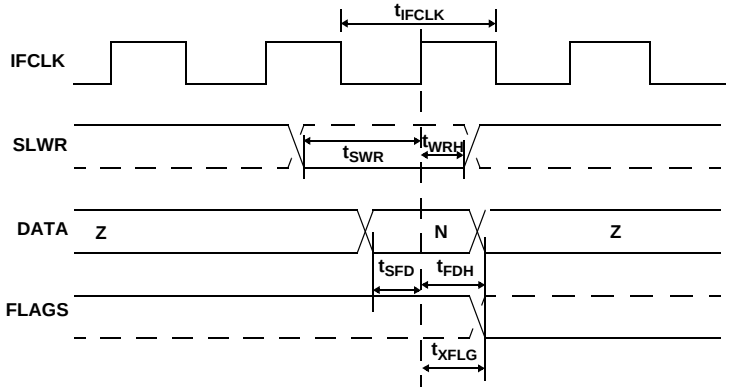


Table 23. Slave FIFO Synchronous Write Parameters with Internally Sourced IFCLK[25]

Parameter	Description	Min	Max	Unit
t_{IFCLK}	IFCLK period	20.83	–	ns
t_{SWR}	SLWR to clock setup time	10.4	–	ns
t_{WRH}	Clock to SLWR hold time	0	–	ns
t_{SFD}	FIFO data to clock setup time	9.2	–	ns
t_{FDH}	Clock to FIFO data hold time	0	–	ns
t_{XFLG}	Clock to FLAGS output propagation time	–	9.5	ns

Table 24. Slave FIFO Synchronous Write Parameters with Externally Sourced IFCLK[25]

Parameter	Description	Min	Max	Unit
t_{IFCLK}	IFCLK Period	20.83	200	ns
t_{SWR}	SLWR to clock setup time	12.1	–	ns
t_{WRH}	Clock to SLWR hold time	3.6	–	ns
t_{SFD}	FIFO data to clock setup time	3.2	–	ns
t_{FDH}	Clock to FIFO data hold time	4.5	–	ns
t_{XFLG}	Clock to FLAGS output propagation time	–	13.5	ns

Slave FIFO Asynchronous Write

Figure 22. Slave FIFO Asynchronous Write Timing Diagram[24]

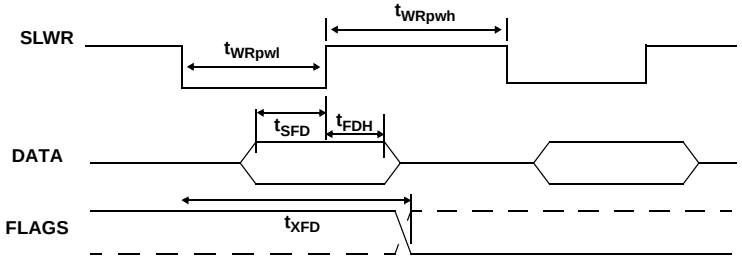
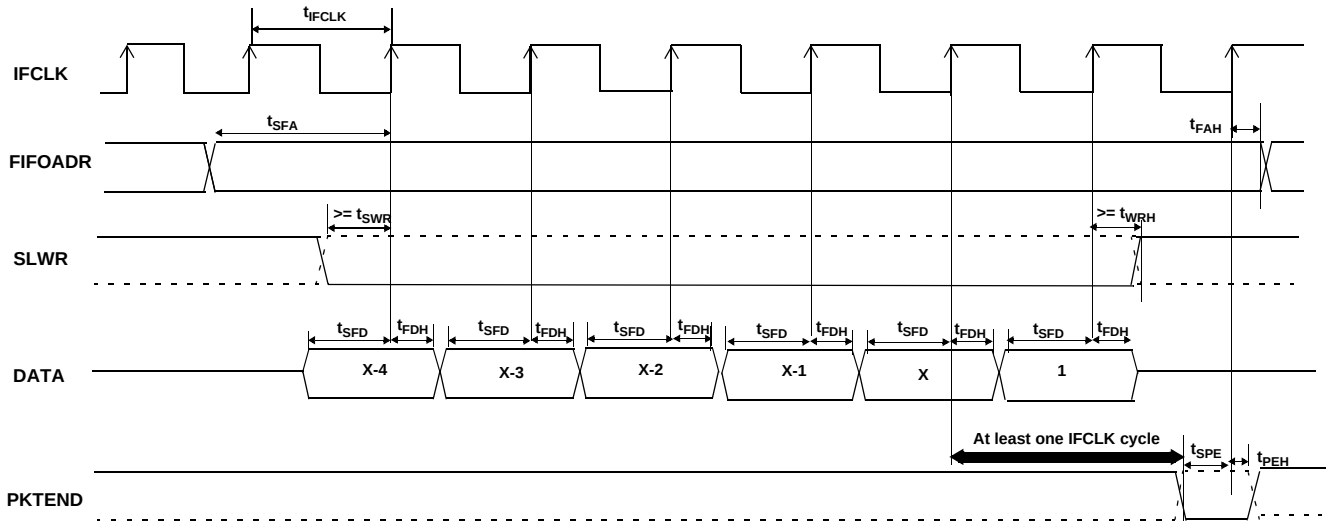


Figure 24. Slave FIFO Synchronous Write Sequence and Timing Diagram[24]



Slave FIFO Asynchronous Packet End Strobe

Figure 25. Slave FIFO Asynchronous Packet End Strobe Timing Diagram[24]

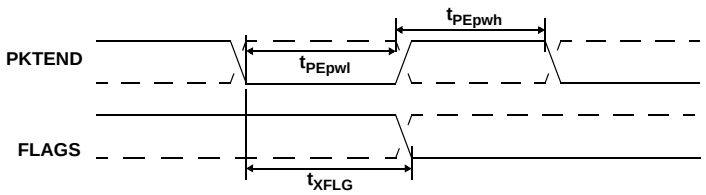


Table 28. Slave FIFO Asynchronous Packet End Strobe Parameters[27]

Parameter	Description	Min	Max	Unit
t_{PEpwl}	PKTEND pulse width LOW	50	–	ns
t_{PWpwh}	PKTEND pulse width HIGH	50	–	ns
t_{XFLG}	PKTEND to FLAGS output propagation delay	–	115	ns

Slave FIFO Output Enable

Figure 26. Slave FIFO Output Enable Timing Diagram[24]

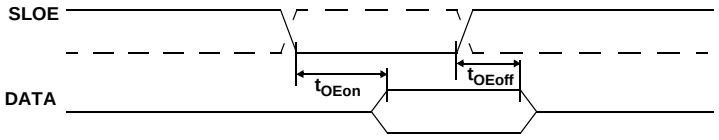


Table 29. Slave FIFO Output Enable Parameters

Parameter	Description	Min	Max	Unit
t_{OEon}	SLOE assert to FIFO DATA output		10.5	ns
t_{OEoff}	SLOE deassert to FIFO DATA hold		10.5	ns

Sequence Diagram of a Single and Burst Asynchronous Write

Figure 35. Slave FIFO Asynchronous Write Sequence and Timing Diagram[24]

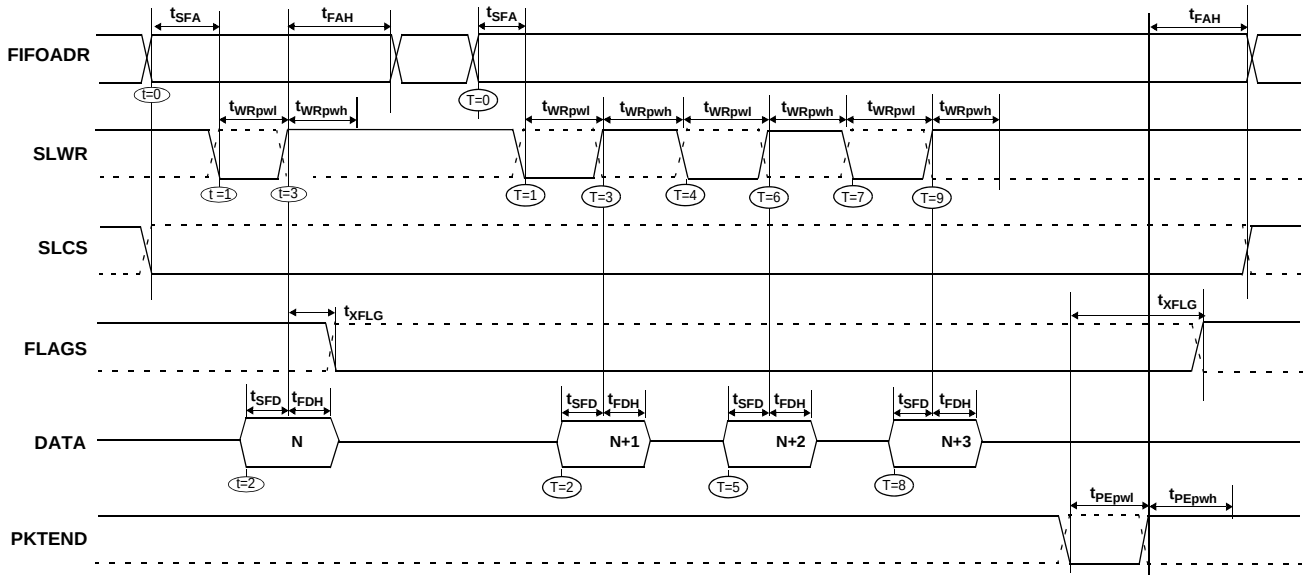


Figure 35 shows the timing relationship of the SLAVE FIFO write in an asynchronous mode. The diagram shows a single write followed by a burst write of 3 bytes and committing the 4byte short packet using PKTEND.

- At t = 0 the FIFO address is applied, ensuring that it meets the setup time of t_{SFA}. If SLCS is used, it must also be asserted (SLCS may be tied LOW in some applications).
- At t = 1 SLWR is asserted. SLWR must meet the minimum active pulse of t_{WRpwl} and minimum de-active pulse width of t_{WRpwh}. If the SLCS is used, it must be asserted with SLWR or before SLWR is asserted.
- At t = 2, data must be present on the bus t_{SFD} before the deasserting edge of SLWR.
- At t = 3, deasserting SLWR causes the data to be written from the data bus to the FIFO and then increments the FIFO pointer. The FIFO flag is also updated after t_{XFLG} from the deasserting edge of SLWR.

The same sequence of events is shown for a burst write and is indicated by the timing marks of T = 0 through 5.

Note In the burst write mode, after SLWR is deasserted, the data is written to the FIFO and then the FIFO pointer is incremented to the next byte in the FIFO. The FIFO pointer is post incremented.

In Figure 35, after the four bytes are written to the FIFO and SLWR is deasserted, the short 4-byte packet can be committed to the host using PKTEND. The external device should be designed to not assert SLWR and the PKTEND signal at the same time. It should be designed to assert the PKTEND after SLWR is deasserted and met the minimum deasserted pulse width. The FIFOADDR lines have to held constant during the PKTEND assertion.

PCB Layout Recommendations

Follow these recommendations to ensure reliable high performance operation:[29]

- Four-layer, impedance-controlled boards are required to maintain signal quality.
- Specify impedance targets (ask your board vendor what they can achieve).
- To control impedance, maintain trace widths and trace spacing.
- Minimize stubs to minimize reflected signals.
- Connections between the USB connector shell and signal ground must be near the USB connector.
- Bypass and flyback caps on VBUS, near connector, are recommended.
- DPLUS and DMINUS trace lengths should be kept to within 2 mm of each other in length, with preferred length of 20 to 30 mm.
- Maintain a solid ground plane under the DPLUS and DMINUS traces. Do not allow the plane to split under these traces.
- Do not place vias on the DPLUS or DMINUS trace routing.
- Isolate the DPLUS and DMINUS traces from all other signal traces by no less than 10 mm.

Note
29. Source for recommendations: *EZ-USB FX2™PCB Design Recommendations*, http://www.cypress.com and *High Speed USB Platform Design Guidelines*, http://www.usb.org/developers/docs/hs_usb_pdg_r1_0.pdf.